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Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

By: Lisa Kaiser

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of:

Joshi et al.

Application No.: Unassigned

Examiner: Luan Thai

Filed: Herewith

Technology Center/Art Unit: 2812

For: FLIP CHIP IN LEADED MOLDED  
PACKAGE AND METHOD OF  
MANUFACTURE THEREOF

PRELIMINARY AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Prior to examination of the above-referenced application, please enter the following amendments and remarks:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Amendments to the Drawings** begin on page 3 of this paper and include an attached replacement sheet.

**Remarks/Arguments** begin on page 6 of this paper.